Abstract of the Disclosure:

An electronic module contains at least one circuit carrier coated on both sides with an electroconductive material and fitted with a first group of electronic components for forming a user interface and a second group of electronic components for forming a computing and control module. A method for producing such a module includes the step of carefully disposing the components respectively on the cover side and on the appliance side of the module in such a way that the configuration and function of the module can be completely unrelated. In order to reduce the production costs of the module, printed circuit boards coated on both sides are used as circuit carriers that are free of STH through-connection points. Accordingly, the signal transmission is carried out via plug-in elements, lateral elements, and through-connection elements.